

October 2014

BC337 / BC338 NPN Epitaxial Silicon Transistor

Features

- Switching and Amplifier Applications
- Suitable for AF-Driver Stages and Low-Power Output Stages
- · Complement to BC327 / BC328



Ordering Information

Part Number	Top Mark	Package	Packing Method	
BC33716BU	BC33716	TO-92 3L	Bulk	
BC33716TA	BC33716	TO-92 3L	Ammo	
BC33716TFR	BC33716	TO-92 3L	Tape and Reel	
BC33725BU	BC33725	TO-92 3L	Bulk	
BC33725TA	BC33725	TO-92 3L	Ammo	
BC33725TAR	BC33725	TO-92 3L	Ammo	
BC33725TF	BC33725	TO-92 3L	Tape and Reel	
BC33725TFR	BC33725	TO-92 3L	Tape and Reel	
BC33740BU	BC33740	TO-92 3L	Bulk	
BC33740TA	BC33740	TO-92 3L	Ammo	
BC33825TA	BC33825	TO-92 3L	Ammo	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter		Value	Unit
V _{CES}	Collector-Emitter Voltage	BC337	50	V
	Collector-Emitter voltage	BC338	30	
V _{CEO}	Collector-Emitter Voltage	BC337	45	V
	Collector-Emitter voltage	BC338	25	
V _{EBO}	Emitter-Base Voltage		5	V
I _C	Collector Current (DC)		800	mA
TJ	Junction Temperature		150	°C
T _{STG}	Storage Temperature		-55 to 150	°C

Thermal Characteristics(1)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
В	Power Dissipation	625	mW
P_{D}	Derate Above 25°C	5.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	200	°C/W

Note:

1. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

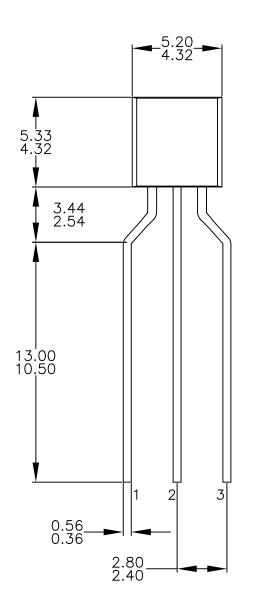
Electrical Characteristics

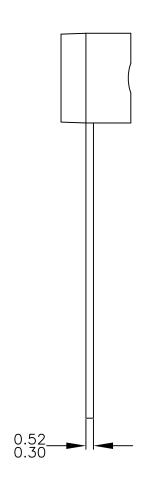
Values are at $T_A = 25$ °C unless otherwise noted.

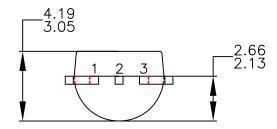
Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit
BV _{CEO}	Collector-Emitter Breakdown Voltage	BC337	$I_C = 10 \text{ mA}, I_B = 0$	45			V
DACEO		BC338		25			
B\/	Collector-Emitter		I - 0.1 m/ \/ - 0	50			V
BV _{CES}	Breakdown Voltage	BC338	$I_C = 0.1 \text{ mA}, V_{BE} = 0$	30			V
BV_{EBO}	Emitter-Base Breakdown Vol	tage	$I_E = 0.1 \text{ mA}, I_C = 0$	5			V
1	Collector Cut-Off Current	BC337	$V_{CE} = 45 \text{ V}, I_{B} = 0$		2	100	nA
I _{CES}		BC338	$V_{CE} = 25 \text{ V}, I_{B} = 0$		2	100	IIA
h _{FE1}	DC Current Gain		$V_{CE} = 1 \text{ V}, I_{C} = 100 \text{ mA}$	100		630	
h _{FE2}			$V_{CE} = 1 \text{ V, } I_{C} = 300 \text{ mA}$	60			
V _{CE} (sat)	Collector-Emitter Saturation Voltage		$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$			0.7	V
V _{BE} (on)	Base-Emitter On Voltage		$V_{CE} = 1 \text{ V, } I_{C} = 300 \text{ mA}$			1.2	V
f _T	Current Gain Bandwidth Product		$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA},$ f = 50 MHz		100		MHz
C _{ob}	Output Capacitance		V _{CB} = 10 V, I _E = 0, f = 1 MHz		12		pF

h_{FE} Classification

Classification	16	25	40
h _{FE1}	100 ~ 250	160 ~ 400	250 ~ 630
h _{FE2}	60 ~	100 ~	170 ~

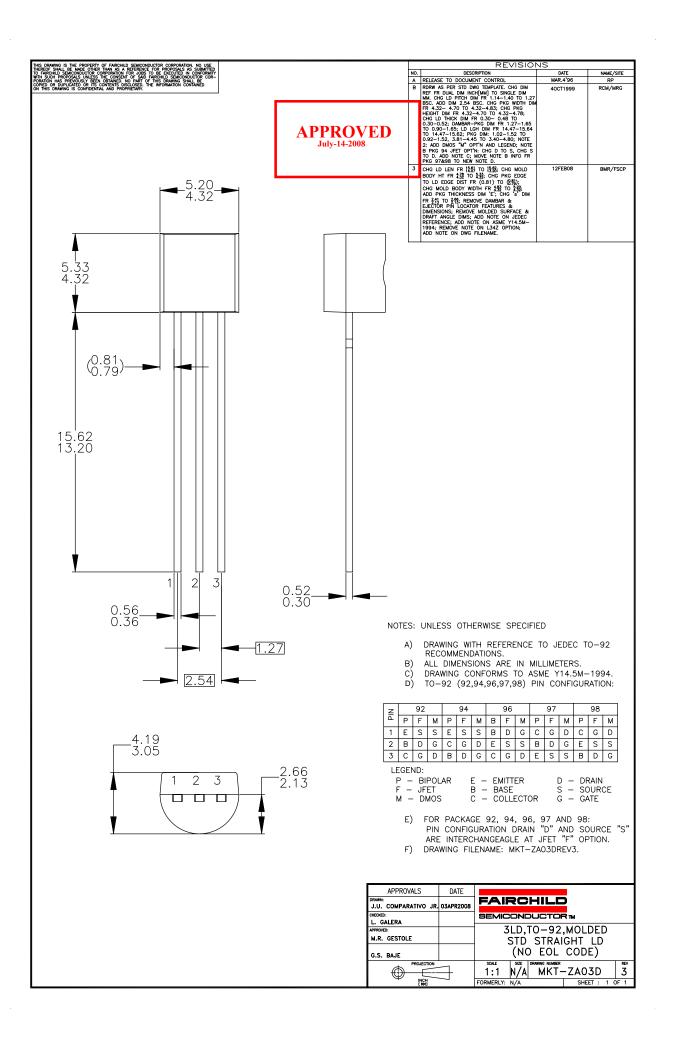






NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING CONFORMS TO JEDEC MS-013, VARIATION AC.
 ALL DIMENSIONS ARE IN MILLIMETERS.
 DRAWING CONFORMS TO ASME Y14.5M-2009.
 DRAWING FILENAME: MKT-ZAO3FREV3.
 FAIRCHILD SEMICONDUCTOR.
- B. C. D. E.







TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ F-PFS™ FRFET® Awinda[®]

AX-CAP®* Global Power ResourceSM

BitSiC™ GreenBridge™ Build it Now™ Green FPS™ CorePLUS™ Green FPS™ e-Series™

CorePOWER™ Gmax™ CROSSVOLT™ GTO™ CTL^{TM} IntelliMAX™

Current Transfer Logic™ ISOPLANAR™ **DEUXPEED®** Making Small Speakers Sound Louder

Dual Cool™ and Better™ EcoSPARK® MegaBuck™

EfficientMax™ MIČROCOUPLER™ ESBC™ MicroFET™ MicroPak™

MicroPak2™ Fairchild® MillerDrive™ Fairchild Semiconductor® MotionMax™ FACT Quiet Series™ MotionGrid® FACT® MTi[®] MTx®

MVN® mWSaver® FPS™ OptoHiT™ OPTOLOGIC®

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

OPTOPLANAR®

PowerTrench® PowerXS™

Programmable Active Droop™

QFET QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM® STEAL TH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™ Sync-Lock™

SYSTEM SYSTEM

TinyBoost[®] TinyBuck[®] TinyCalc™ TinyLogic[®] TINYOPTO™ TinvPower™ TinyPWM™ TinyWire™ TranSiC™ TriFault Detect™

TRUECURRENT®* uSerDes™

UHC'

Ultra FRFET™ UniFET™ VCX^{TM} VisualMax™ VoltagePlus™ XSTM. Xsens™ 仙童™

DISCLAIMER

FastvCore™

FFTBench™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT HTTP://WWW.FAIRCHILDSEMI.COM. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS. SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms					
Datasheet Identification	Product Status	Definition			
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.			
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.			
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.			
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.			

Rev. 172